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**SF2167E** 

1382.24 MHz **SAW Filter** 



- SAW Filter for Digital Television
- Complies with Directive 2002/95/EC (RoHS)



### **Characteristics:**

Balance-to-balanced operation

Terminating source/load impedance:  $Z_S = 150 \Omega$ 

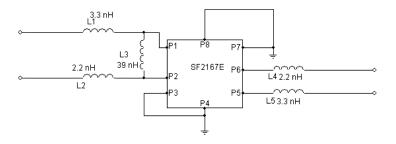
### **Maximum Rating**

Rating	Value	Units
Input Power Level	0	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-50 to +95	°C
Maximum Soldering Profile, 5 cycles/ 10 seconds maximum	265	°C

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f <sub>C</sub>			1382.24		MHz
Insertion Loss, 1362.24 to 1402.24 MHz	IL			3.4	4.5	dB
Amplitude Ripple, 1362.24 to 1402.24 MHz				0.5	2.0	dB
Group Delay Ripple, 1362.24 to 1402.24 MHz				10	30	ns <sub>P-P</sub>
Attenuation, 0 dB Reference:						
500 to 1300.18 MHz			42	52		
1464.30 to 1490 MHz			45	50		dB
1490 to 2000 MHz			40	50		

Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint	
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	854, YWWS	
Standard Reel Quantity Reel Size 7 inch	500 Pieces/Reel	
Reel Size 13 inch	3000 Pieces/Reel	

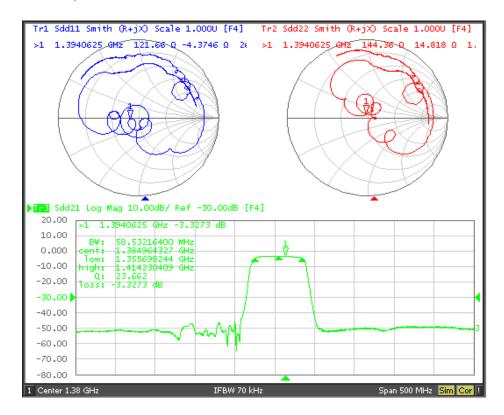
### Tuning Network, 150 ohm Balanced Source/Load



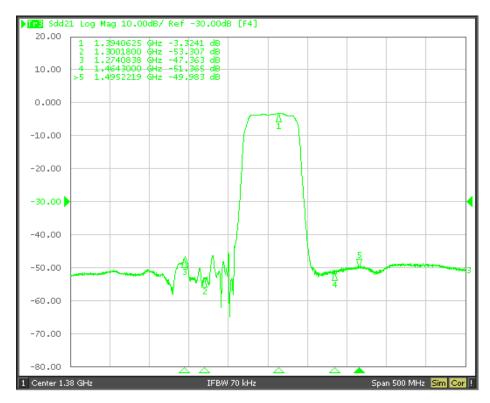


- US and international patents may apply.
- Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.
- Electrostatic Sensitive Device. Observe precautions for handling.

### Filter Wideband S21, S11 and S22 Plots



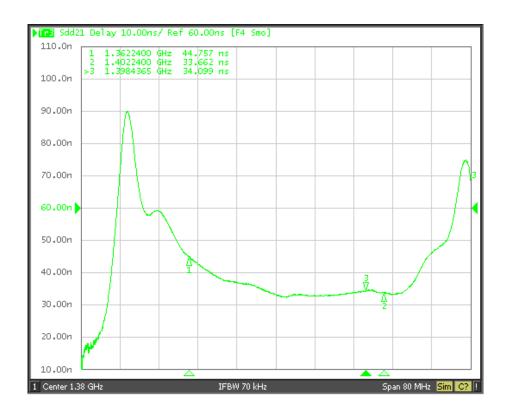
## **Filter Shape Factor Plot**



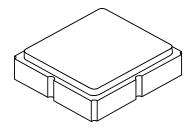
### **Filter Passband Plot**

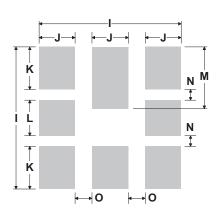


### **Filter Group Delay Plot**



# 8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





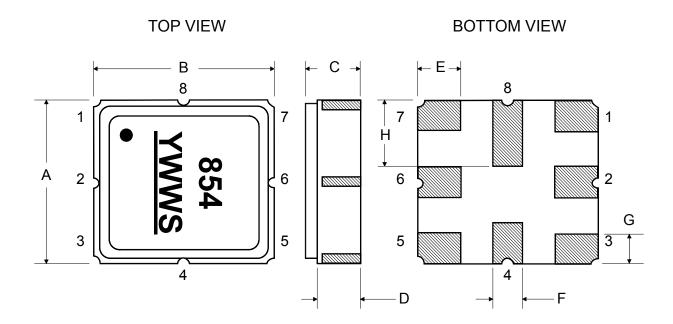
**PCB Footprint Top View** 

### **Case and PCB Footprint Dimensions**

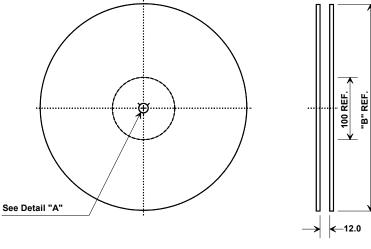
Dimension	mm			Inches			
Difficusion	Min	Nom	Max	Min	Nom	Max	
Α	2.87	3.0	3.13	0.113	0.118	0.123	
В	2.87	3.0	3.13	0.113	0.118	0.123	
С	1.14	1.27	1.40	0.045	0.050	0.055	
D	0.79	0.92	1.05	0.031	0.036	0.041	
E	0.62	0.75	0.88	0.024	0.029	0.034	
F	0.47	0.60	0.73	0.018	0.024	0.029	
G	0.47	0.60	0.73	0.018	0.024	0.029	
Н	1.07	1.20	1.33	0.042	0.047	0.052	
I		3.19			0.126		
J		0.81			0.032		
K		0.96			0.038		
L		0.81			0.032		
М		1.39			0.055		
N		0.23			0.009		
0		0.38			0.015		

#### **Case Materials**

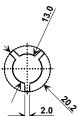
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				



### **Tape and Reel Specifications**



•	'B"	Quantity Per Reel
Inches	millimeters	Qualitity For Roof
7	178	500
13	330	3000



### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions	
Ao	3.35 mm
Во	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm

